

Applications

- Low phase noise oscillators up to 16 GHz
- VCO's, DRO's and YIG oscillators
- Point-to-point radios
- Satellite communications
- Fiber optics, OC-192 and OC-768
- Local Multipoint Distribution Systems, LMDS

Features

- Low 1/f noise: -142 dBc/Hz at 100 Hz offset
- Phase noise: -167 dBc/Hz at 100 kHz offset
- Output power up to +13 dBm
- Operation down to 1 volt, 2 mA
- Gold bump pads for wire bond or flip chip (for direct die attachment)

Product Description

The LPT16ED is a silicon germanium low phase noise, high frequency NPN transistor for oscillator applications up to 16GHz.

The transistor exhibits low 1/f noise and provides +13 dBm typical output power at V_{CE} of 3V and I_C equal to 20 mA. It is easily operated from a single supply voltage with appropriate external passive components.

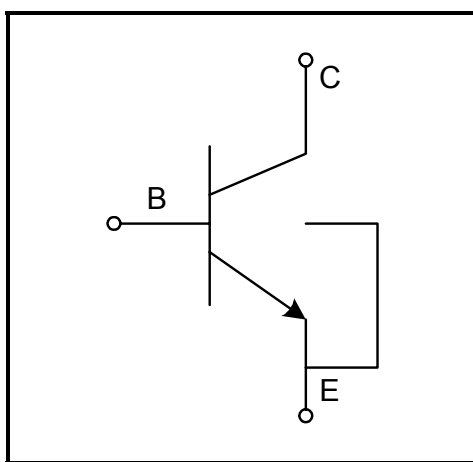
The silicon germanium technology used in this device provides outstanding high-frequency performance combined with high thermal conductivity and superior reliability under harsh operating and storage conditions.

A complete mechanical description of the transistor is available under SiGe Semiconductor Document 07MS001.

Ordering Information

Type	Package	Remark
LPT16ED	Bare Die	Shipped in Waffle Pack

Functional Block Diagram



Absolute Maximum Ratings

Operation in excess of any one of Absolute Maximum Ratings may result in permanent damage. This is a high performance RF device with ESD rating < 2keV. Handling and assembly of this device should be done at ESD protected workstations.

Symbol	Parameter	Min.	Max.	Unit
V _{CBO}	Collector to Base Voltage		+13.0	V
V _{CEO}	Collector to Emitter Voltage		+4.0	V
V _{EBO}	Emitter to Base Voltage		+1.5	V
I _C	Collector Current		80	mA
I _B	Base Current		2.0	mA
P _T	Total Power Dissipation		250	mW
T _J	Junction Temperature		+150	°C
T _{STG}	Storage Temperature	-65	+150	°C

DC Electrical Characteristics

Conditions: T_A = unless otherwise specified 25°C

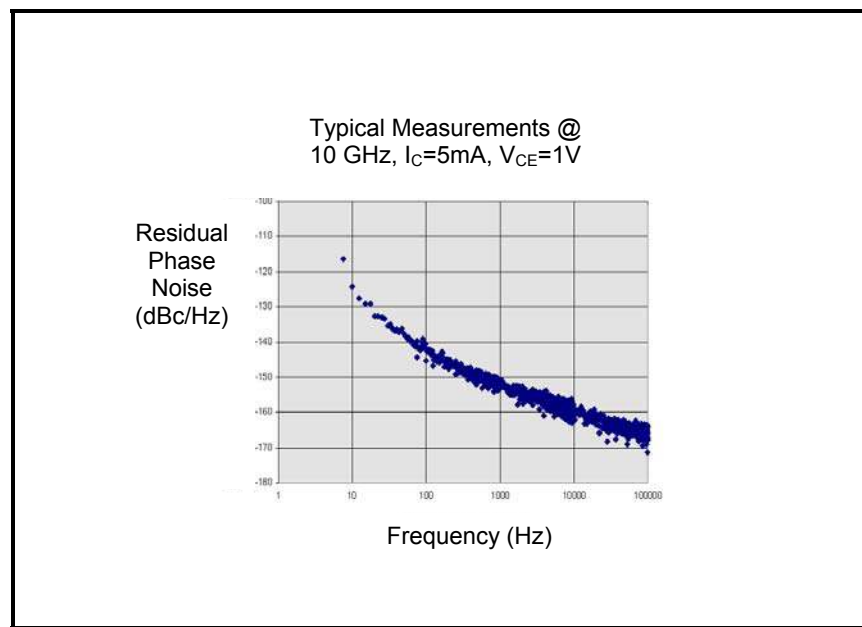
Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V _{BE}	Base-emitter voltage	I _C = 1μA	670	687	700	mV
BV _{CEO}	Collector-emitter breakdown voltage	Open base	4.0	4.5	5.0	V
BV _{CES}	Collector-emitter breakdown voltage	Base-emitter shorted via 100kΩ	14	15.0	16	V
BV _{EBO}	Emitter-base breakdown voltage	I _E = 100μA, open collector	2.0	2.3	2.6	V
BV _{CBO}	Collector-base breakdown voltage	Open emitter	14	15.0	16	V
V _A	Early voltage	I _C = 10mA, V _{CE} = 3V	100	200	300	V
I _{CBO}	Collector-base cutoff current	V _{CB} = 5V and I _E = 0			100	pA
I _{EBO}	Emitter-base cutoff current	V _{EB} = 1.5V and I _C = 0	5	10	15	μA
h _{FE}	DC current gain	V _{CE} = 2V, I _C = 20mA	50	60	150	

AC Electrical Characteristics

Symbol	Parameter	Note	Min.	Typ.	Max.	Unit
IS ₂₁ l ₂	Insertion Power Gain (Z _S = Z _L = 50Ω)	V _{CE} = 1.5V, I _C = 10mA, f = 16GHz	0.7	1.0	1.3	dB
		V _{CE} = 3.0V, I _C = 20mA, f = 16GHz	2.3	2.6	2.9	dB
MAG/ MSG	Maximum Available Gain or Maximum Stable Gain	V _{CE} = 1.5V, I _C = 10mA, f = 16GHz	3.3	3.6	4.2	dB
		V _{CE} = 3.0V, I _C = 20mA, f = 16GHz	4.9	5.2	5.6	dB

Typical Performance Characteristics

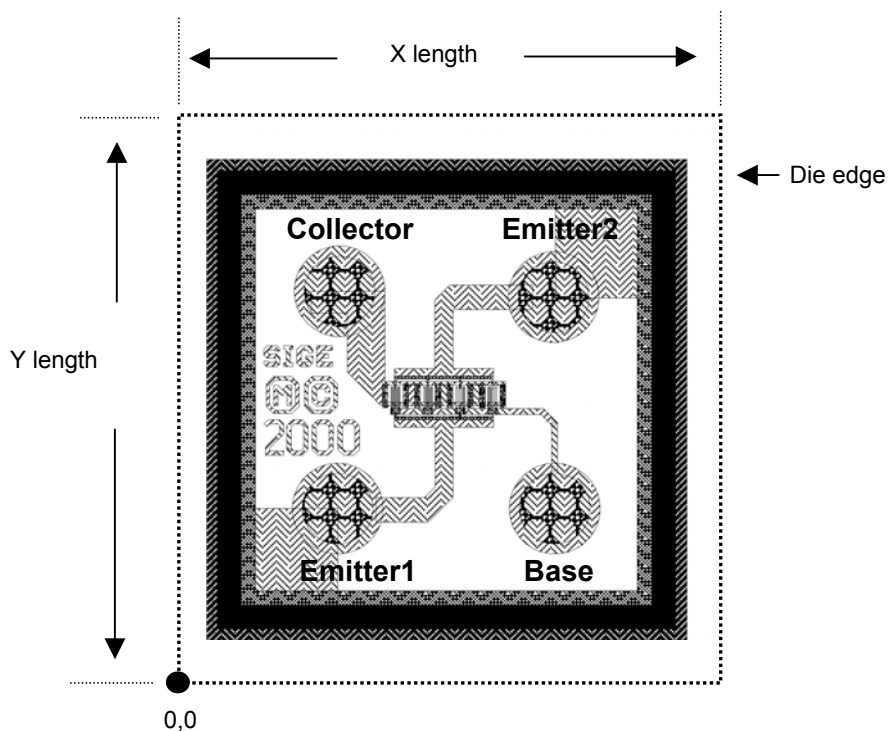
Please refer to application note (Document 07AN001).



Typical Applications Information

Series or parallel feedback oscillators at 5-16 GHz. (Please refer to application note, Document 07AN001).

Die and Pad Description



Dimensions are relative to the 0,0 cut die corner.

Feature	Specification	Comments
Die thickness	10 mil +/- 1mil	
X length	15.3 mil +/- 1mil	
Y length	14.5 mil +/- 1mil	
Pad diameter	2.9 mil +/- 0.1mil	Pads are circular.
Pad pitch	6 mil +/- 0.1mil	Pad center to pad centre
Pad/bump height	1 mil +/- 0.05mil	
Pad/bump co-planarity	0.2 mil	

Pad Center	Position (X mil, Y mil) +/- 0.7mil relative to the 0,0 cut die corner
Collector	5, 11
Emitter1	5, 5
Base	11, 5
Emitter 2	11, 11

Please refer to Document 01-MS-001 for SiGe's die inspection criteria.

For S-parameter data, please refer to SiGe Document 07SP001.

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Product Preview

The datasheet contains information from the product concept specification. SiGe Semiconductor Inc. reserves the right to change information at any time without notification.

Preliminary Information

The datasheet contains information from the design target specification. SiGe Semiconductor Inc. reserves the right to change information at any time without notification.

Final

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